

UTC UNISONIC TECHNOLOGIES CO., LTD

3N70A **Power MOSFET**

700V, 3A N-CHANNEL POWER MOSFET

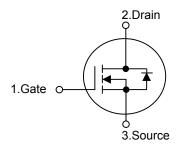
DESCRIPTION

The UTC 3N70A is a high voltage and high current power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in the high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



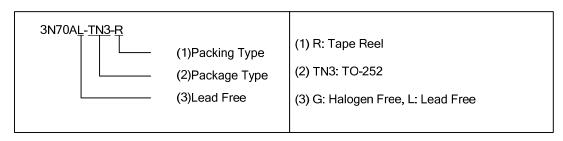
- * $R_{DS(ON)} \le 4.0\Omega$ @ $V_{GS} = 10 \text{ V}$
- * Ultra low gate charge (typical 10 nC)
- * Low reverse transfer capacitance
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

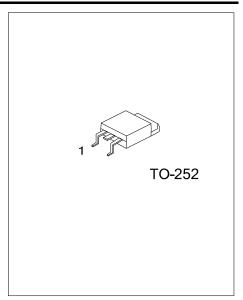
SYMBOL



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N70AL-TN3-R	3N70AG-TN3-R	TO-252	G	D	S	Tape Reel	





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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage		V _{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	3.0	А
Continuous Drain Current		I _D	3.0	А
Pulsed Drain Current (Note 2)		I _{DM}	12	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	200	mJ
	Repetitive (Note 2)	E _{AR}	7.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		P _D	50	W
Junction Temperature		TJ	+150	°C
Operating Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 64mH, I_{AS} = 2.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 3.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ_{JC}	2.5	°C/W	

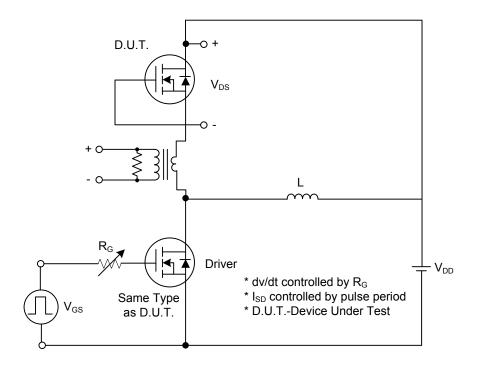
■ ELECTRICAL CHARACTERISTICS (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V			10	μΑ	
Cata Source Leakage Current Forv	vard	loss	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
Gate-Source Leakage Current Rev	erse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS} / \triangle T_J$	I _D =250μA,Referenced to 25°C		0.6		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{A}$		2.8	4.0	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C_{ISS}	V _{DS} = 25 V, V _{GS} = 0 V, f =		350	450	pF	
Output Capacitance		C_{OSS}	1MHz		50	65	pF	
Reverse Transfer Capacitance		C_{RSS}	TIVII IZ		5.5	32	pF	
SWITCHING CHARACTERISTICS								
Turn-On Delay Time		t _{D(ON)}			10	40	ns	
Turn-On Rise Time		t_R	$V_{DD} = 30V, I_D = 1.0 A,$		30	70	ns	
Turn-Off Delay Time		t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		20	100	ns	
Turn-Off Fall Time		t _F			30	70	ns	
Total Gate Charge		Q_G	V _{DS} = 480V,I _D = 3.0A,		10	13	nC	
Gate-Source Charge		Q_GS	V _{DS} = 460V,I _D = 3.0A, V _{GS} = 10V (Note 1, 2)		2.7		nC	
Gate-Drain Charge		Q_{DD}	V _{GS} - 10 V (NOIE 1, 2)		4.9		nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A}$			1.4	V	
Maximum Continuous Drain-Source Diode		Is				3.0	Α	
Forward Current						5.0	^	
Maximum Pulsed Drain-Source Diode		I _{SM}				12	Α	
Forward Current						14	^	
Reverse Recovery Time	t _{rr}	$V_{GS} = 0 \text{ V}, I_S = 3.0 \text{ A},$		210		ns		
Reverse Recovery Charge		Q_{RR}	dI _F /dt = 100 A/μs (Note 1)		1.2		μC	

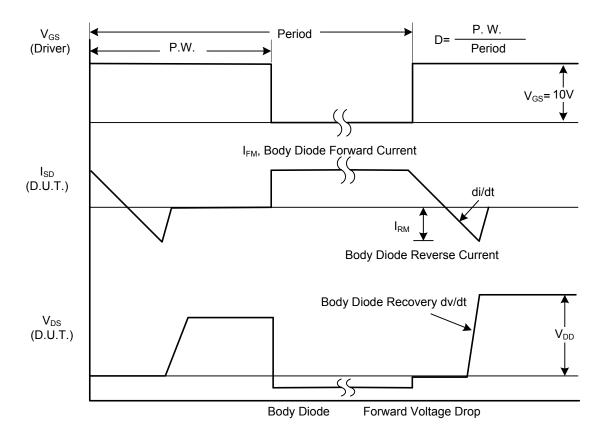
Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

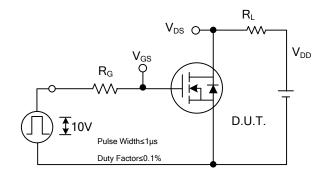


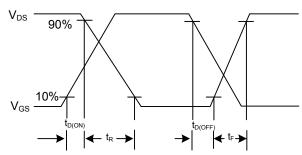
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

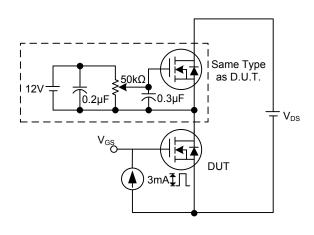
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

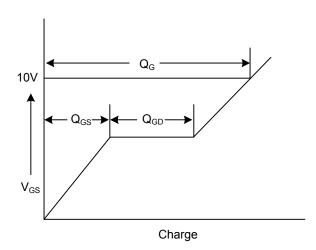




Switching Test Circuit

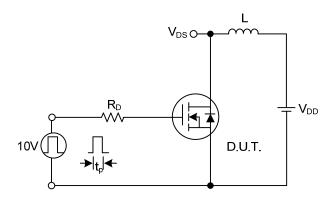
Switching Waveforms

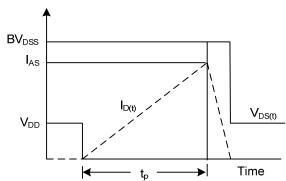




Gate Charge Test Circuit

Gate Charge Waveform

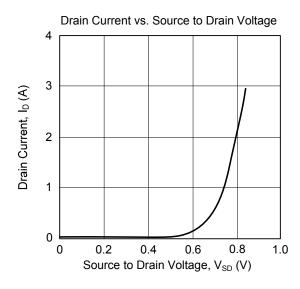


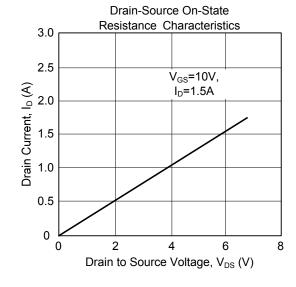


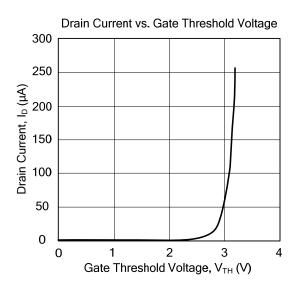
Unclamped Inductive Switching Test Circuit

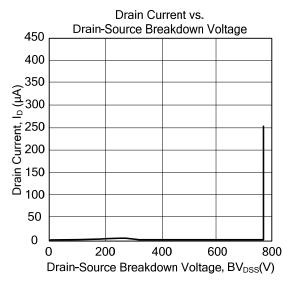
Unclamped Inductive Switching Waveforms

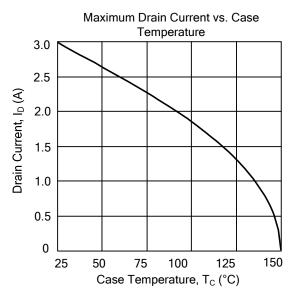
■ TYPICAL CHARACTERISTICS











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